SMS05C, SMS12C, SMS15C, SMS24C

5-Line Transient Voltage Suppressor Array

This 5-line voltage transient suppressor array is designed for application requiring transient voltage protection capability. It is intended for use in over-transient voltage and ESD sensitive equipment such as computers, printers, automotive electronics, networking communication and other applications. This device features a monolithic common anode design which protects five independent lines in a single SC-74 package.

Features

- Protects up to 5 Lines in a Single SC–74 Package
- Peak Power Dissipation 350 W (8 \times 20 µs Waveform)
- ESD Rating of Class 3B (Exceeding 8.0 kV) per Human Body Model and Class C (Exceeding 400 V) per Machine Model
- Compliance with IEC 61000–4–2 (ESD) 15 kV (Air), 8.0 kV (Contact)
- Flammability Rating of UL 94 V-0
- Pb–Free Package is Available

Applications

- Hand–Held Portable Applications
- Networking and Telecom
- Automotive Electronics
- Serial and Parallel Ports
- Notebooks, Desktops, Servers

MAXIMUM RATINGS (T_J = 25° C unless otherwise specified)

Symbol	Rating	Value	Unit
P _{PK} 1	Peak Power Dissipation $8 \times 20 \ \mu s$ Double Exponential Waveform (Note 1)	350	W
TJ	Operating Junction Temperature Range	-40 to 125	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
TL	Lead Solder Temperature (10 s)	260	°C
ESD	Human Body Model (HBM) Machine Model (MM) IEC 61000-4-2 Air (ESD) IEC 61000-4-2 Contact (ESD)	>8000 >400 >15000 >8000	V

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

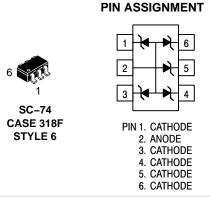
1. Non-repetitive current pulse per Figure 3.



ON Semiconductor[®]

http://onsemi.com

SC-74 FIVE TRANSIENT VOLTAGE SUPPRESSOR 350 W PEAK POWER



MARKING DIAGRAM



x = SMS05C:J = SMS12C:K

- = SMS12C.K
- = SMS13C.L = SMS24C:M
- = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
SMS05CT1	SC-74	3000/Tape & Reel
SMS12CT1	SC-74	3000/Tape & Reel
SMS15CT1	SC-74	3000/Tape & Reel
SMS15CT1G	SC–74 (Pb–Free)	3000/Tape & Reel
SMS24CT1	SC-74	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

SMS05C, SMS12C, SMS15C, SMS24C

SMS05C ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse Working Voltage	V _{RWM}	(Note 2)			5.0	V
Breakdown Voltage	V _{BR}	I _T = 1.0 mA (Note 3)	6.2		7.2	V
Reverse Leakage Current	I _R	V _{RWM} = 5.0 V			5.0	μA
Clamping Voltage	V _C	I _{PP} = 5.0 A (8 \times 20 μ s Waveform)			9.8	V
Clamping Voltage	V _C	I_{PP} = 24 A (8 \times 20 μ s Waveform)			14.5	V
Maximum Peak Pulse Current	I _{PP}	8 $ imes$ 20 μ s Waveform			24	А
Capacitance	CJ	$V_R = 0 V$, f = 1.0 MHz (Line to GND)		260	400	pF

SMS12C ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Min	Тур	Мах	Unit
Reverse Working Voltage	V _{RWM}	(Note 2)			12	V
Breakdown Voltage	V _{BR}	I _T = 1.0 mA (Note 3)	13.3		15	V
Reverse Leakage Current	I _R	V _{RWM} = 12 V		0.001	1.0	μΑ
Clamping Voltage	V _C	I_{PP} = 5.0 A (8 \times 20 μs Waveform)			19	V
Clamping Voltage	V _C	I_{PP} = 15 A (8 \times 20 μs Waveform)			23	V
Maximum Peak Pulse Current	I _{PP}	$8\times20\mu s$ Waveform			15	А
Capacitance	CJ	$V_R = 0 V$, f = 1.0 MHz (Line to GND)		120	150	pF

SMS15C ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified) (See Note 4)

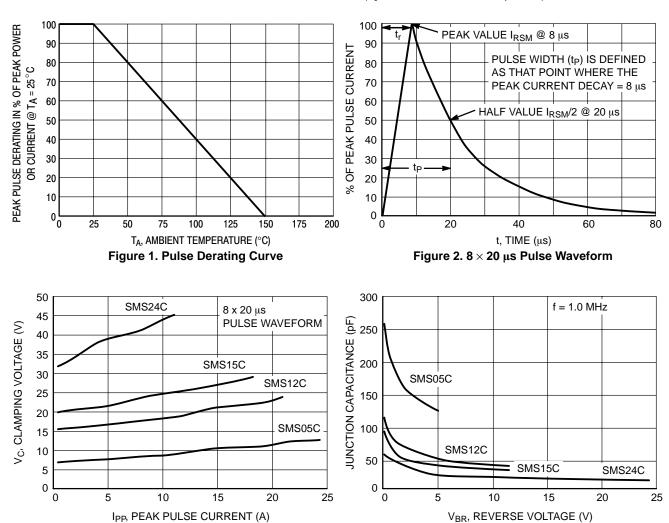
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse Working Voltage	V _{RWM}	(Note 2)			15	V
Breakdown Voltage	V _{BR}	I _T = 1.0 mA (Note 3)	17		19	V
Reverse Leakage Current	I _R	V _{RWM} = 15 V		0.05	1.0	μΑ
Clamping Voltage	V _C	I_{PP} = 5.0 A (8 \times 20 μs Waveform)			24	V
Clamping Voltage	V _C	I_{PP} = 12 A (8 \times 20 μ s Waveform)			29	V
Maximum Peak Pulse Current	I _{PP}	$8 \times 20 \mu s$ Waveform			12	А
Capacitance	CJ	$V_R = 0 V$, f = 1.0 MHz (Line to GND)		95	125	pF

SMS24C ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$, unless otherwise specified)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse Working Voltage	V _{RWM}	(Note 2)			24	V
Breakdown Voltage	V _{BR}	I _T = 1.0 mA (Note 3)	26.7		32	V
Reverse Leakage Current	I _R	V _{RWM} = 24 V		0.001	1.0	μΑ
Clamping Voltage	V _C	I_{PP} = 5.0 A (8 \times 20 μs Waveform)			40	V
Clamping Voltage	V _C	I_{PP} = 8 A (8 \times 20 μ s Waveform)			44	V
Maximum Peak Pulse Current	I _{PP}	$8 \times 20 \mu s$ Waveform			8.0	А
Capacitance	CJ	$V_R = 0 V$, f = 1.0 MHz (Line to GND)		60	75	pF

2. TVS devices are normally selected according to the working peak reverse voltage (V_{RWM}), which should be equal or greater than the DC or continuous peak operating voltage level. 3. V_{BR} is measured at pulse test current I_T . 4. Parametrics are the same for the Pb–Free packages, which are suffixed with a "G".

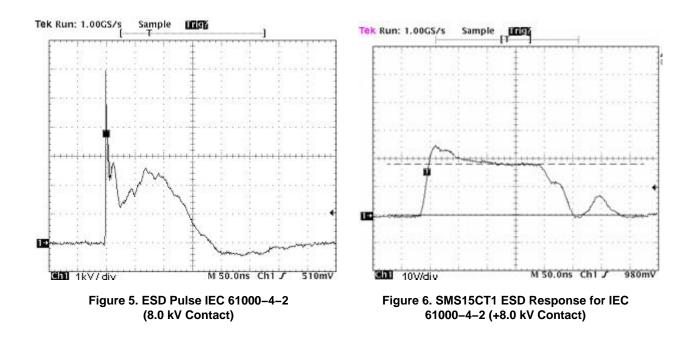
SMS05C, SMS12C, SMS15C, SMS24C



TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise specified)

Figure 3. Clamping Voltage vs. Peak Pulse Current





SMS05C, SMS12C, SMS15C, SMS24C

TYPICAL COMMON ANODE APPLICATIONS

A 5 TVS junction common anode design in a SC-74 package protects four separate lines using only one package. This adds flexibility and creativity to PCB design especially

when board space is at a premium. A simplified example of SMS05C Series Device applications is illustrated below.

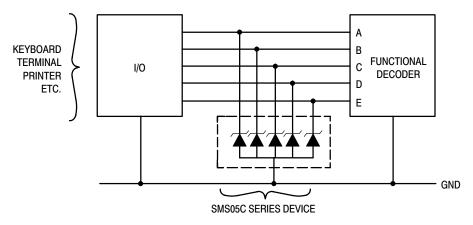
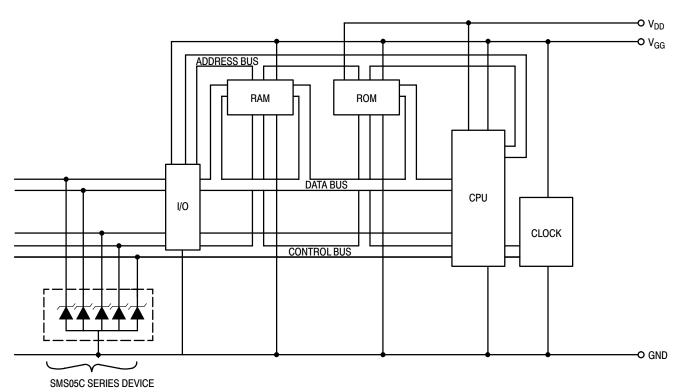


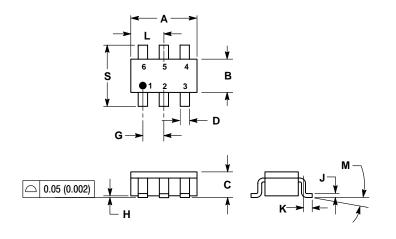
Figure 7. Computer Interface Protection





PACKAGE DIMENSIONS

SC-74 CASE 318F-05 **ISSUE K**



NOTES:

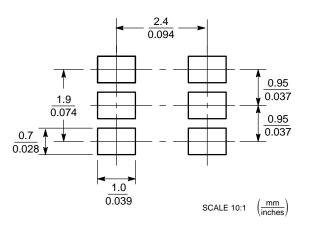
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.1142	0.1220	2.90	3.10	
В	0.0512	0.0669	1.30	1.70	
C	0.0354	0.0433	0.90	1.10	
D	0.0098	0.0197	0.25	0.50	
G	0.0335	0.0413	0.85	1.05	
н	0.0005	0.0040	0.013	0.100	
J	0.0040	0.0102	0.10	0.26	
K	0.0079	0.0236	0.20	0.60	
L	0.0493	0.0649	1.25	1.65	
М	0 °	10 °	0 °	10 °	
S	0.0985	0.1181	2.50	3.00	

STYLE 6:

PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any provided in SCILLC data sheets and/or specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights or other solution in which the failure of the SCILLC product creat e situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 61312, Phoenix, Arizona 85082–1312 USA Phone: 480–829–7710 or 800–344–3860 Toll Free USA/Canada Fax: 480–829–7709 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800–282–9855 Toll Free USA/Canada

Japan: ON Semiconductor, Japan Customer Focus Center 2–9–1 Kamimeguro, Meguro–ku, Tokyo, Japan 153–0051 Phone: 81–3–5773–3850 ON Semiconductor Website: http://onsemi.com

Order Literature: http://www.onsemi.com/litorder

For additional information, please contact your local Sales Representative.